KEMET Part Number: C0805X821JCGACTU

(C0805X821JCGAC7800)



SMD Comm C0G HV Flex, Ceramic, 820 pF, 5%, 500 VDC, C0G, SMD, MLCC, FT-CAP, Ultra-Stable, 0805



Dimensions	
L	2mm +/-0.3mm
W	1.25mm +/-0.3mm
Т	1.25mm +/-0.15mm
S	0.75mm MIN
В	0.5mm +/-0.25mm

Packaging Specifications		
Packaging:	T&R, 180mm, Plastic Tape	
Packaging Quantity:	2500	

General Information		
Supplier:	KEMET	
Series:	SMD Comm C0G HV Flex	
Style:	SMD Chip	
Description:	SMD, MLCC, FT-CAP, Ultra- Stable	
Features:	FT-CAP, Ultra-Stable	
RoHS:	Yes	
Termination:	Flexible Termination	
Marking:	No	
Chip Size:	0805	

Specifications		
Capacitance:	820 pF	
Capacitance Tolerance:	5%	
Voltage DC:	500 VDC	
Dielectric Withstanding Voltage:	750 V	
Temperature Range:	-55/+125C	
Temperature Coefficient:	COG	
Dissipation Factor:	0.10% 1MHz 25C	
Aging Rate:	0% Loss/Decade Hour	
Insulation Resistance:	100 GOhms	

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